



# **Outgassing of Space Materials at Low Temperature**

## **CCMPP-2021**

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**CNES**

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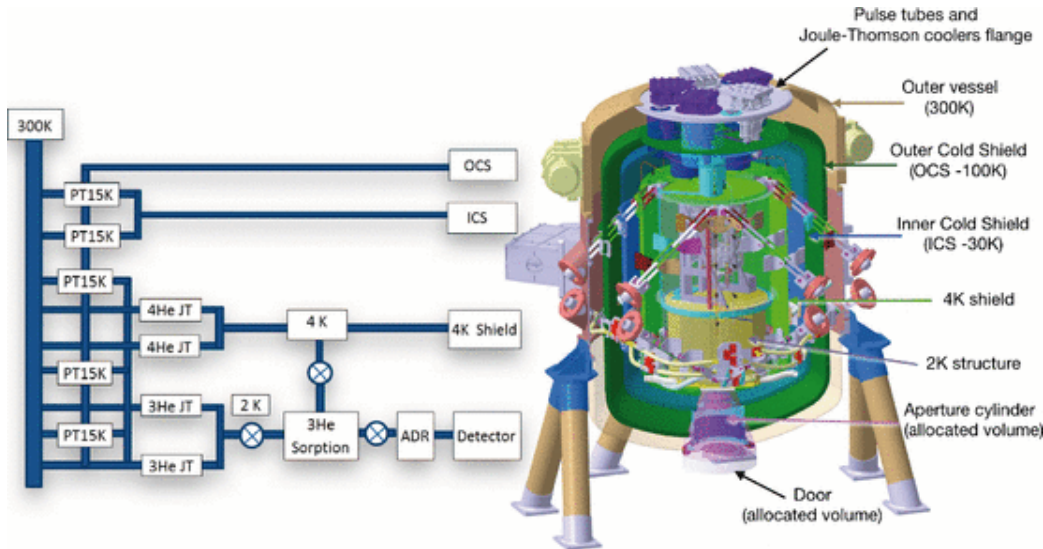
- Facility
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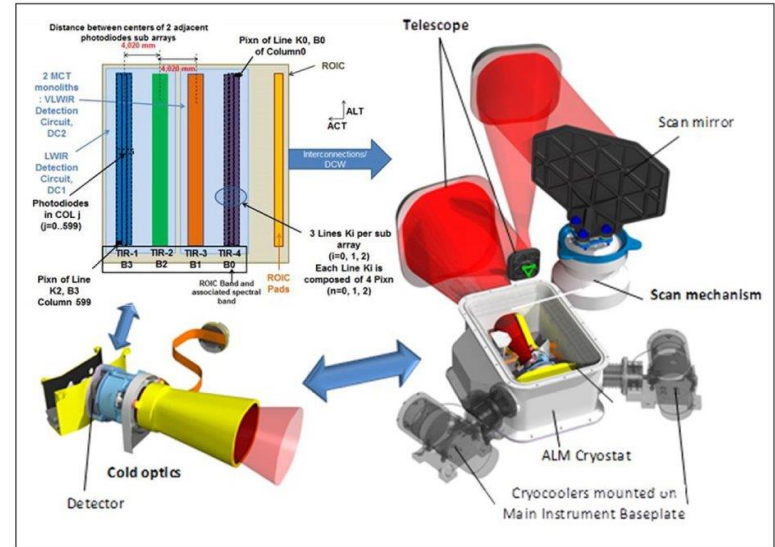
# Introduction

Increase of cryogenic missions  
 Cryogenic temperature → sensitive surfaces → performance affected by contamination



## The Athena X-ray Integral Field Unit (X-IFU)

Pajot, F., Barret, D., Lam-Trong, T. *et al.*, The Athena X-ray Integral Field Unit (X-IFU). *J Low Temp Phys* 193, 901–907 (2018)



## Trishna

Buffet L., Gamet P., Maisongrande P. *et al.*, The TIR instrument on TRISHNA satellite: a precursor of high resolution observation missions in the thermal infrared domain, *Proc SPIE 11852*, International Conference on Space Optics - ICSO 2020, 118520Q (2021)

MicroCarb, MTG, CO2M, LSTM, CHIME and others...

Outgassing at cryogenic temperature → intuition to be negligible → no experimental data

# Introduction

**Objectives: to quantify the outgassing at cryogenic temperature**

## Optimization of CNES facilities

Measurements of outgassing kinetics of widely used space materials



Cooling of materials, protocol modification...

Identification of the chemical nature of outgassed molecules



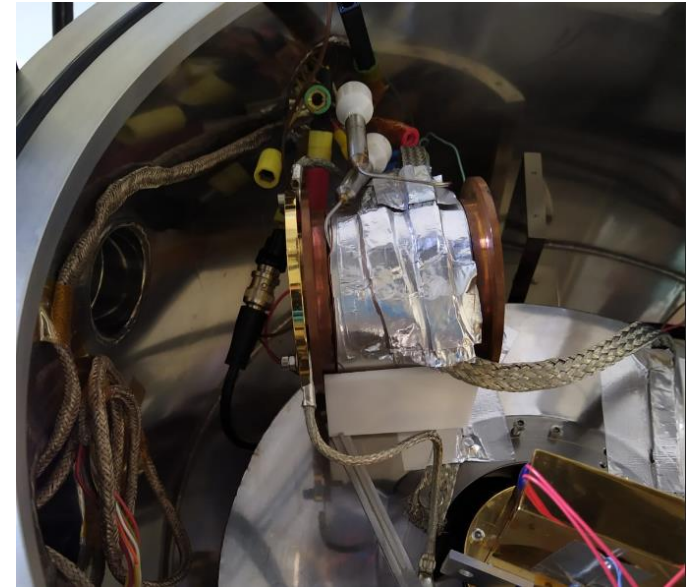
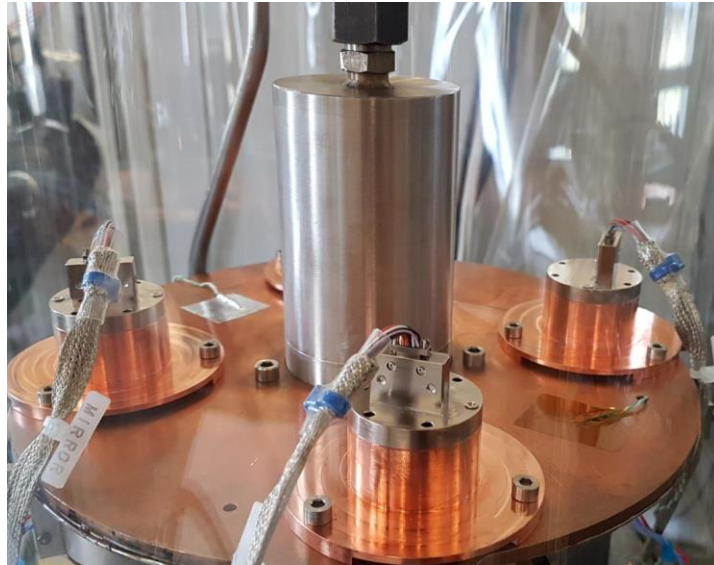
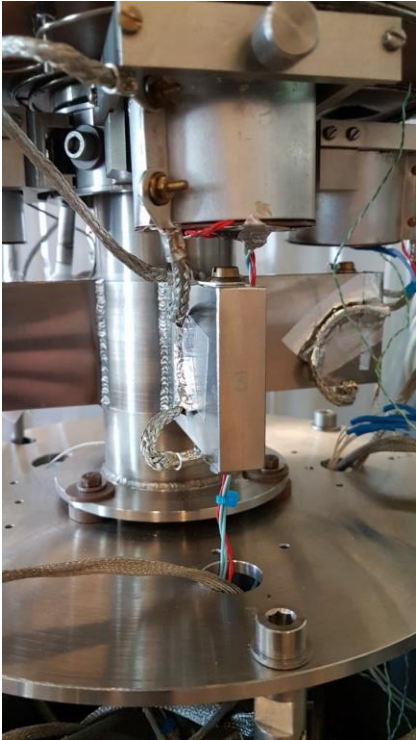
RGA analysis, modification of oven location...

Prediction of outgassing at low temperature



Fitting with Arrhenius law...

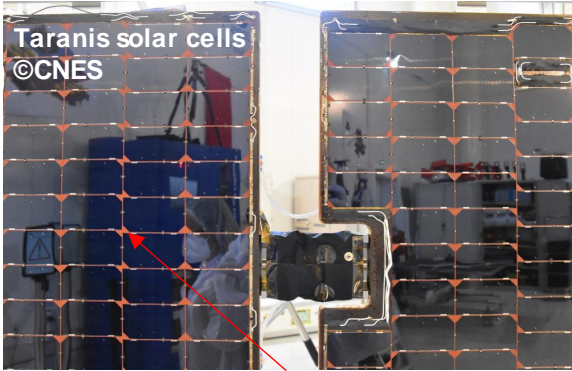
## Optimization of CNES facilities



Optimization of thermal control to cool down the oven  
at cryogenic temperature

Optimization of oven temperature and location  
→ RGA sensitivity

## Materials and protocol



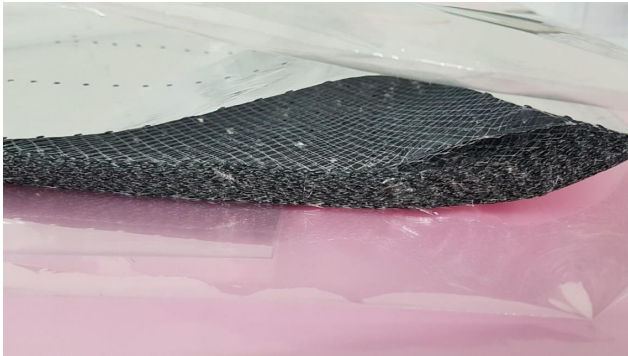
*RTV-S 691 adhesive*

### *Parameters:*

- About 12 g of material
- NDK<sup>®</sup> CQCM,  $S = 2.38 \cdot 10^8 \text{ (Hz/g)/cm}^2$
- $T_{\text{CQCM}} = -165 \text{ }^\circ\text{C}$
- $T_{\text{material}} = -75 \text{ }^\circ\text{C to } 25 \text{ }^\circ\text{C}$

### *Protocol:*

- Samples are loaded into ovens
- $\text{GN}_2$  flushing during a certain duration then  $\text{LN}_2$  cooling at ambient pressure
- At a certain temperature, vacuum system was switched on
- Cooling till  $-165 \text{ }^\circ\text{C}$
- Start of the temperature stages and RGA analysis

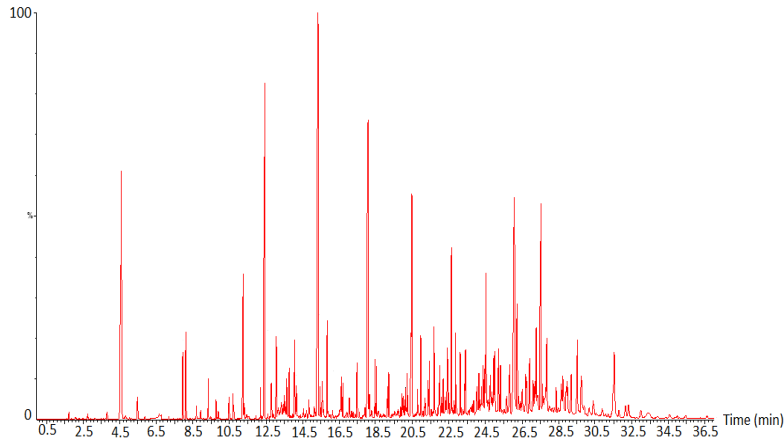


*Cryogenic MLI (52 sheets + PE spacers)*

## TDGCMS

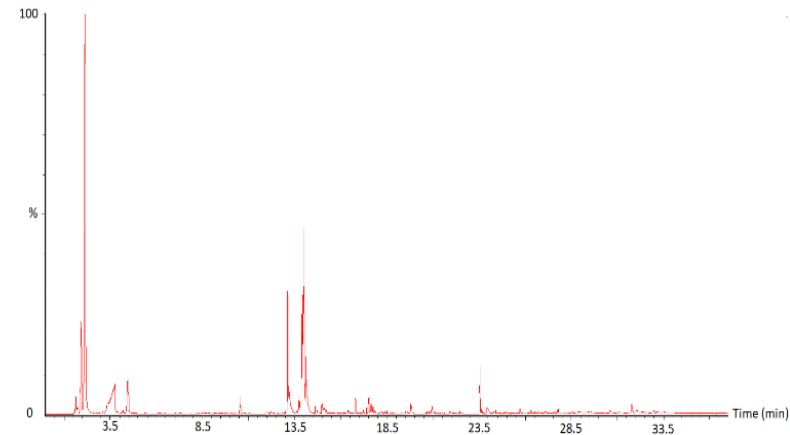
Gas chromatography (GC) analysis performed with a Clarus 500 chromatograph (PerkinElmer Elite 5-MS column with dimensions of 60 m × 0.25 mm × 0.25 μm) coupled to a TurboxMatrix 300 TD thermal desorber (TD) and a Clarus 500 mass spectrometer (MS)

Parameters: 200 °C, solvent delay of 1 min, ambient pressure



*RTV-S 691 adhesive chromatogram*

- benzene at retention time (tr) = 4.6 min
- toluene (tr = 7.9 min)
- cyclic and linear siloxanes (tr = 12.4, 15.3, 18.1, 20.5, 26.1, 27.5 min, and so on)

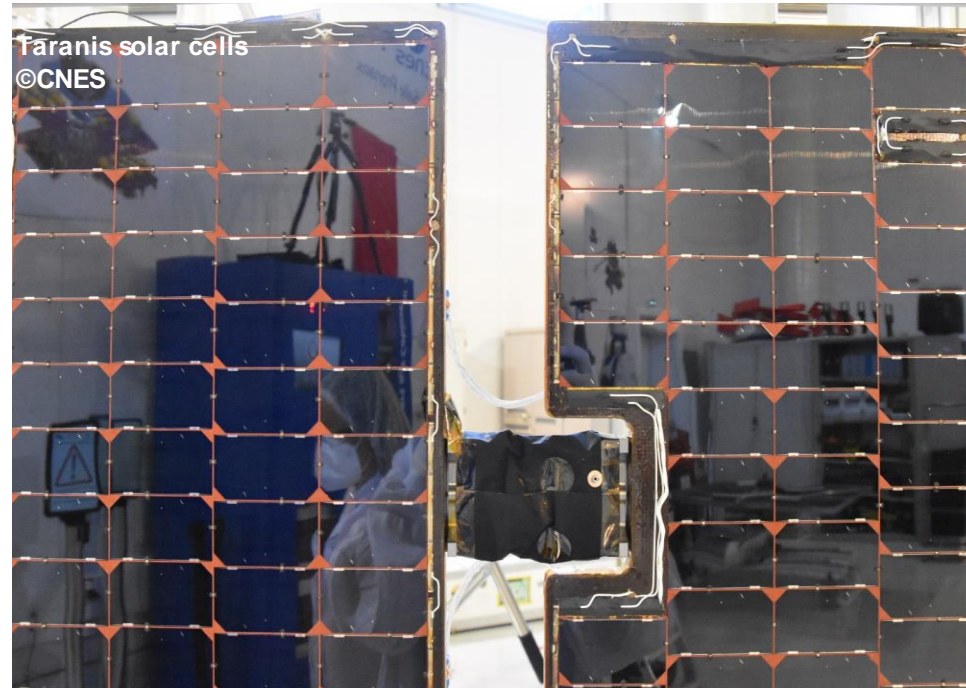


*Cryogenic MLI chromatogram*

- benzoic acid, phenyl ester (tr = 23.5 min)
- alcohols such as 1-heptanol, 6-methyl- (tr = 13.9 min)

# Measurements

*RTV-S 691 adhesive*

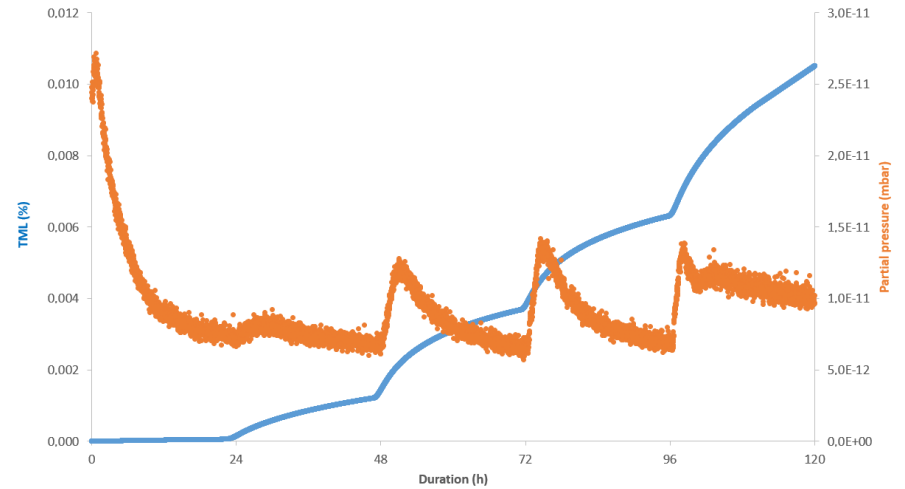
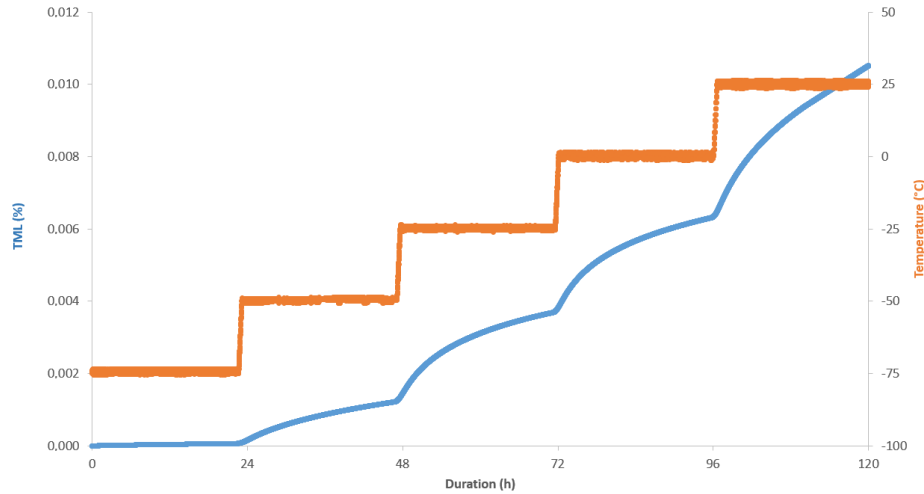




# Measurements

## RTV-S 691 adhesive: outgassing and RGA analysis (water desorption)

12 g of material,  $T_{RTV-S691} = -75^{\circ}\text{C}$  to  $25^{\circ}\text{C}$ ,  $T_{CQCM} = -165^{\circ}\text{C}$



Outgassing starts from  $-50^{\circ}\text{C}$  (0.001 %)

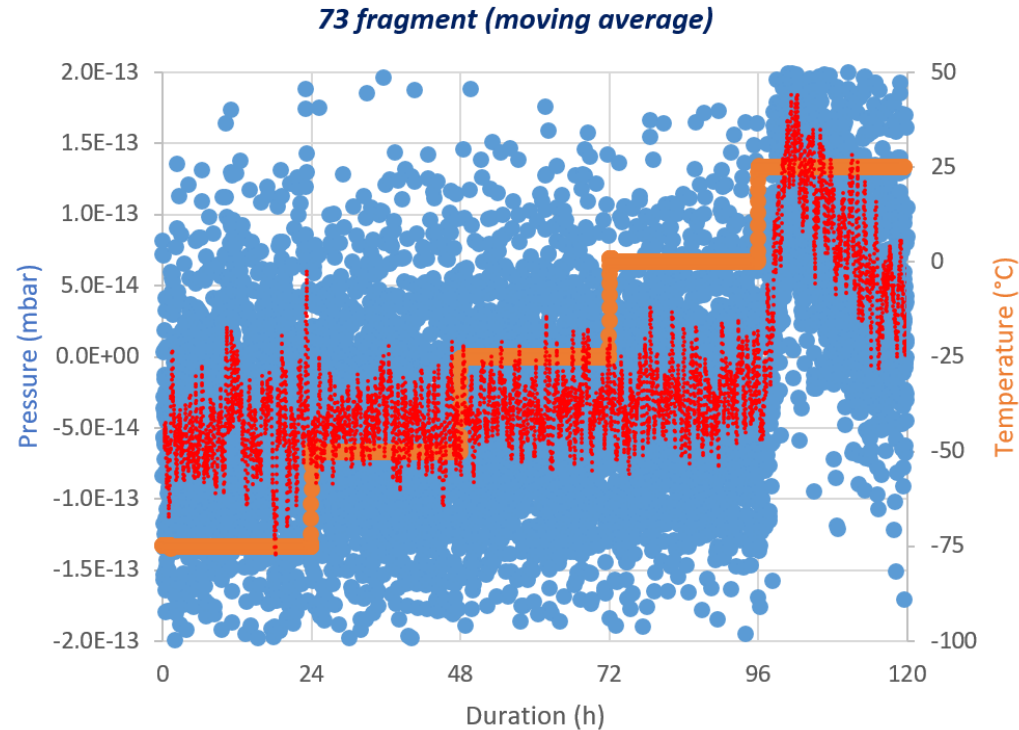
Water starts to desorb from  $-50^{\circ}\text{C}$  and regularly up to  $25^{\circ}\text{C}$

$$\Delta P_{18_{-50^{\circ}\text{C}}} = 2.0 \cdot 10^{-12} \text{ mbar} ; \Delta P_{18_{-25^{\circ}\text{C}}} = 6.0 \cdot 10^{-12} \text{ mbar} ; \Delta P_{18_{0^{\circ}\text{C}}} = 7.5 \cdot 10^{-12} \text{ mbar} ; \Delta P_{18_{25^{\circ}\text{C}}} = 7.0 \cdot 10^{-12} \text{ mbar}$$

# Measurements

## RTV-S 691 adhesive, RGA analysis

Siloxane fragment: SiC<sub>3</sub>H<sub>9</sub>



Silicone fragment might start to desorb from 0 °C but significantly from 25 °C

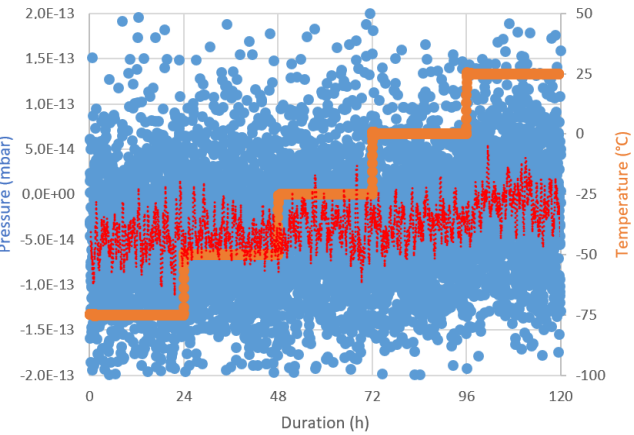
$$\Delta P_{73\_25^{\circ}\text{C}} = 2.5 \cdot 10^{-13} \text{ mbar}$$

# Measurements

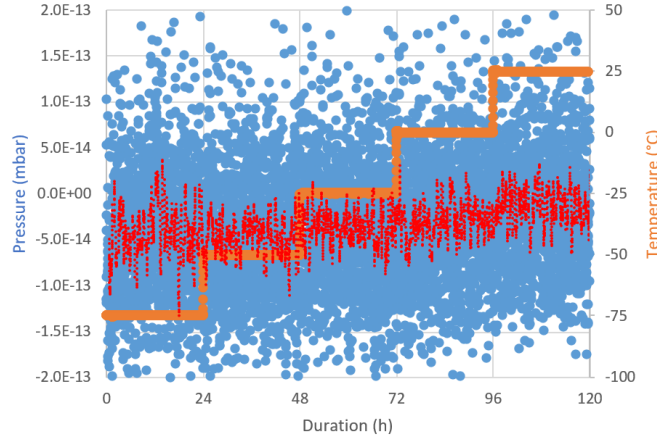
## RTV-S 691 adhesive, RGA analysis

### Benzene fragments: $C_6H_6$ , $C_6H_5$ , $C_4H_3$ , $C_3H_3$

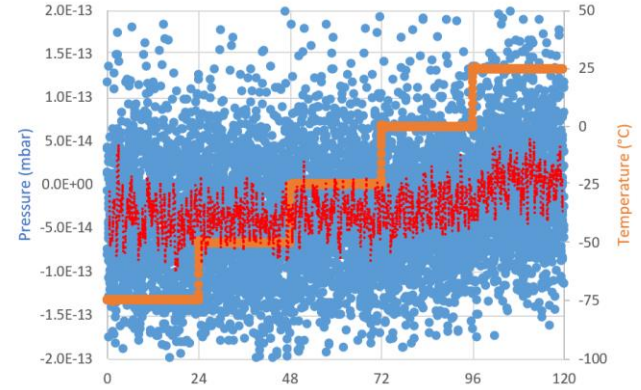
78 fragment (moving average)



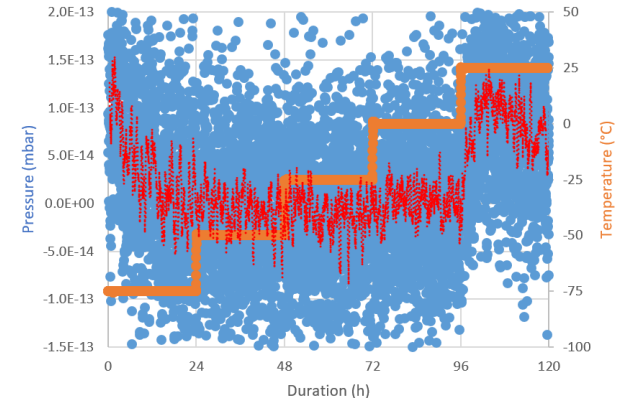
77 fragment (moving average)



51 fragment (moving average)



39 fragment (moving average)



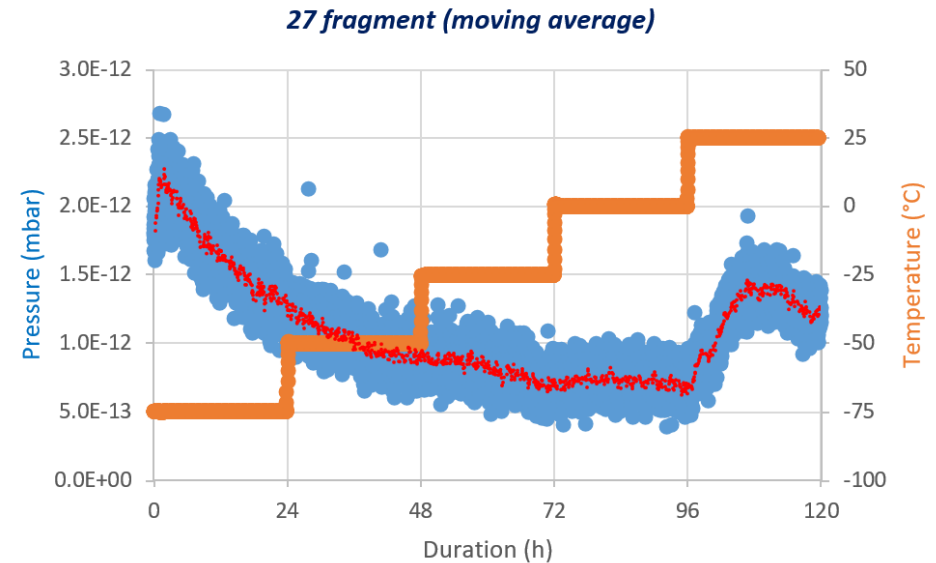
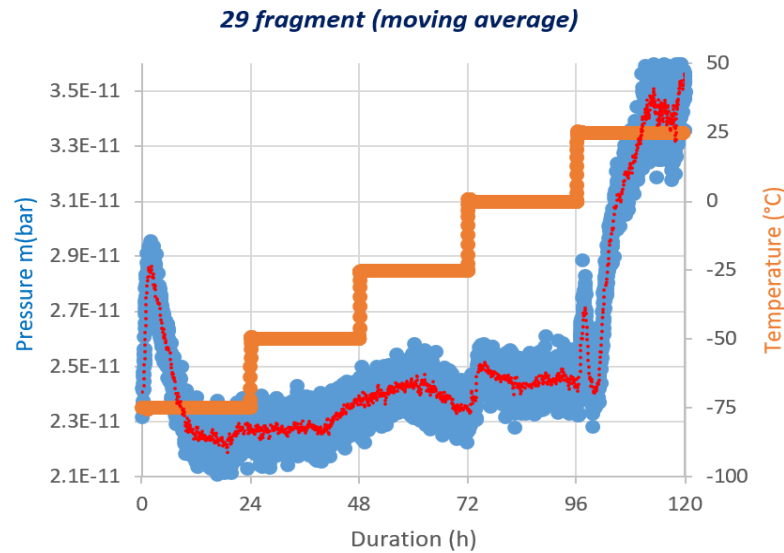
Benzene fragments might start to desorb from 0 °C

$$\Delta P_{39\_25^\circ C} = 1.5 \cdot 10^{-13} \text{ mbar}$$

# Measurements

## RTV-S 691 adhesive, RGA analysis

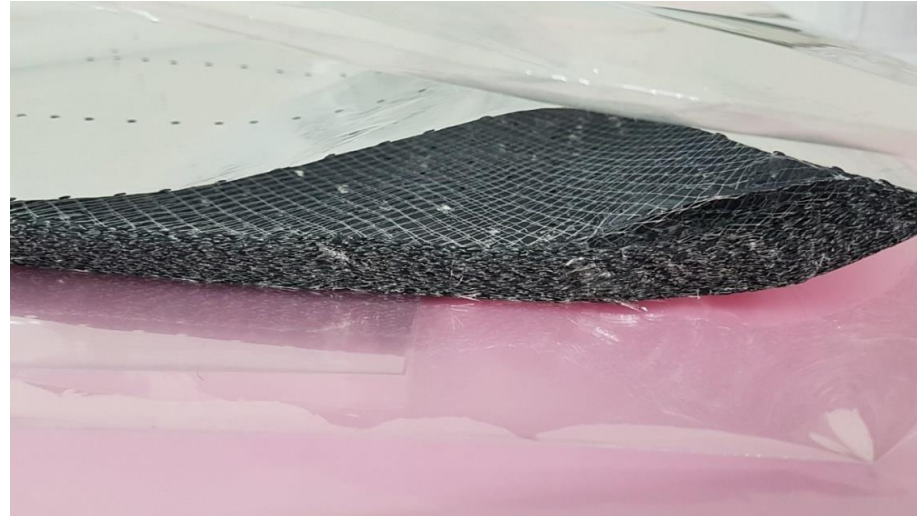
C<sub>x</sub>H<sub>y</sub> fragments: C<sub>2</sub>H<sub>5</sub>, C<sub>2</sub>H<sub>3</sub>



Low mass C<sub>x</sub>H<sub>y</sub> fragments start to desorb from -75 °C but significantly from 25 °C  
 $\Delta P_{29,-75^{\circ}\text{C}} = 5.5 \cdot 10^{-12}$  mbar ;  $\Delta P_{29,25^{\circ}\text{C}} = 1.1 \cdot 10^{-11}$  mbar ;  $\Delta P_{27,25^{\circ}\text{C}} = 1.5 \cdot 10^{-12}$  mbar

# Measurements

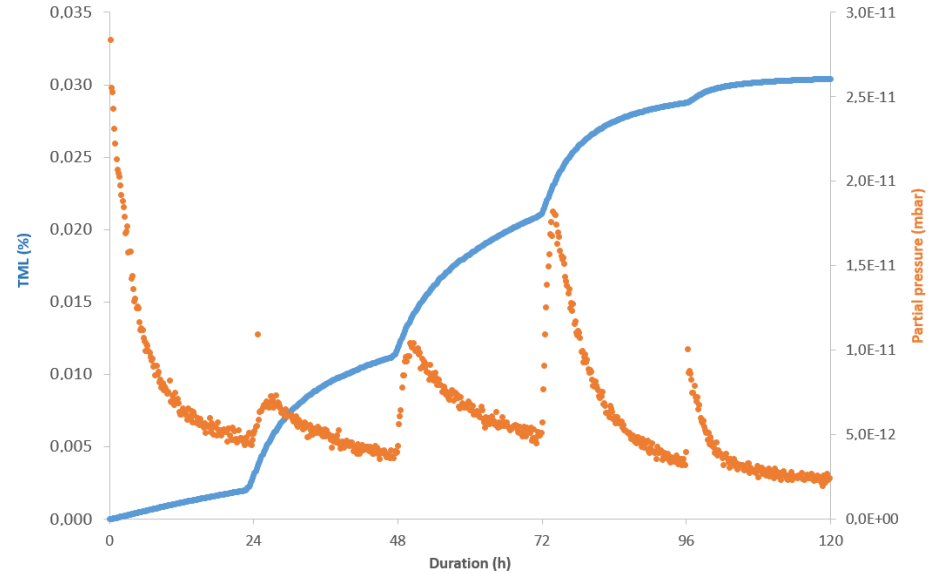
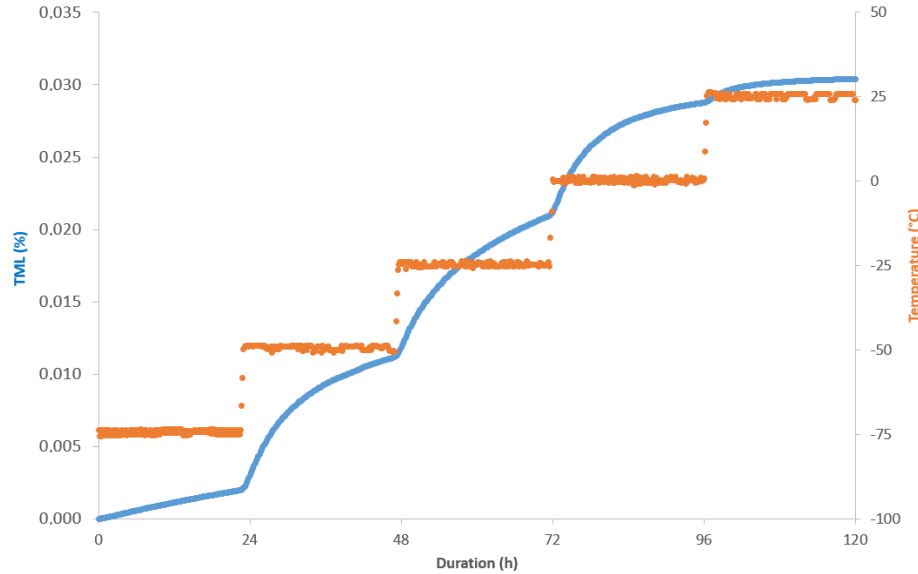
*Cryogenic MLI*



# Measurements

## Cryogenic MLI: outgassing and RGA analysis (water desorption)

12 g of material,  $T_{MLF} = -75^{\circ}\text{C}$  to  $25^{\circ}\text{C}$ ,  $T_{CQCM} = -165^{\circ}\text{C}$



Outgassing starts from  $-75^{\circ}\text{C}$  (0.002 %)

Water starts to desorb from  $-50^{\circ}\text{C}$  and regularly up to  $25^{\circ}\text{C}$

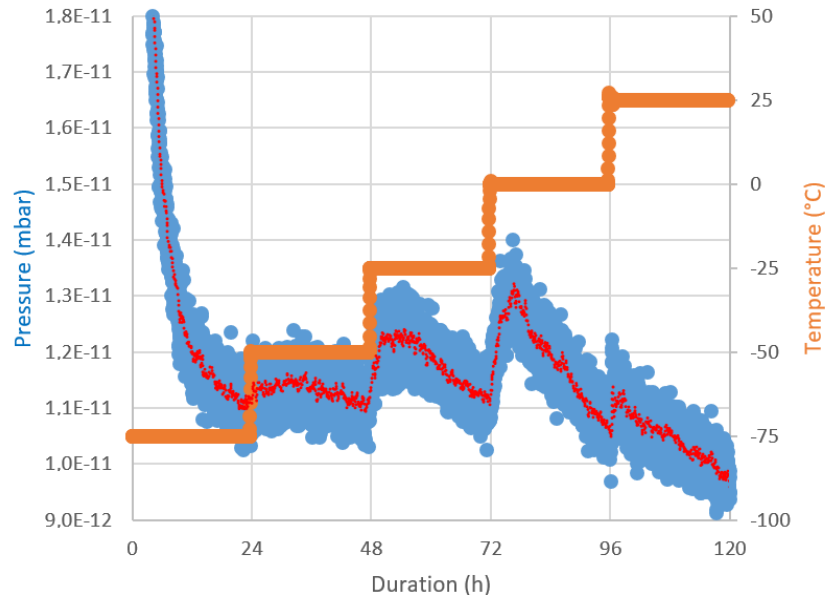
$\Delta P_{18_{-50^{\circ}\text{C}}} = 2.0 \cdot 10^{-12}$  mbar ;  $\Delta P_{18_{-25^{\circ}\text{C}}} = 6.0 \cdot 10^{-12}$  mbar ;  $\Delta P_{18_{0^{\circ}\text{C}}} = 12.0 \cdot 10^{-12}$  mbar ;  $\Delta P_{18_{25^{\circ}\text{C}}} = 7.0 \cdot 10^{-12}$  mbar

# Measurements

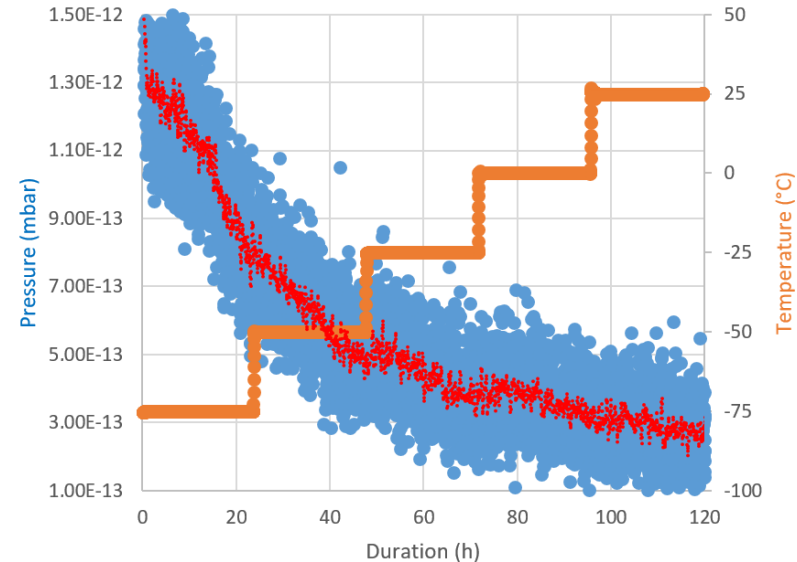
## Cryogenic MLI, RGA analysis

$C_xH_y$  fragments:  $C_2H_5$ ,  $C_2H_3$

29 fragment (moving average)



27 fragment (moving average)



Low mass  $C_xH_y$  fragments start to desorb from  $-50\text{ }^\circ\text{C}$

$\Delta P_{29_{-50^\circ\text{C}}} = 5.0 \cdot 10^{-13}\text{ mbar}$  ;  $\Delta P_{29_{-25^\circ\text{C}}} = 1.0 \cdot 10^{-12}\text{ mbar}$  ;  $\Delta P_{29_{0^\circ\text{C}}} = 2.0 \cdot 10^{-12}\text{ mbar}$

# Fitting

LP/VB5E → computation, simulation and database

- Computation part → first order desorption law, consideration of 5 outgassed chemical species with decreasing volatility, linear temperature slope

$$\frac{d\mu(t)}{dt} = k_{i(t)}(\mu_i - \mu_{i(t)}) \text{ with } \mu_{i(t_0)} = 0$$

$$\mu(t) = \sum_{i=1}^n \int_{t_0}^t (\mu_i - \mu_{i(t)}) \cdot (1 - e^{-k_{i(t)} dt})$$

$$k_{i(t)} = A_i e^{\frac{-E_i}{RT(t)}}$$

→ to find the coefficients ( $\mu$ ,  $E$ ,  $A$ )<sub>1 to 5</sub> from the multi-step test

- Simulation part enables to simulate outgassing graphs for a given material using coefficients ( $\mu$ ,  $E$ ,  $A$ )<sub>1 to 5</sub> with different temperature profiles
- Database → to be re-used for other computation



# Fitting

Coefficient values after fitting of each experimental curve for cryogenic MLI and RTV-S 691 adhesive

		Cryogenic MLI	RTV-S 691 adhesive
Exponential 1	$\mu$ (%)	$1.10^{-3}$	0
	E (kcal / mol)	1.6	1
	A (1 / s)	$3.10^{-3}$	$9.10^{-4}$
Exponential 2	$\mu$ (%)	$9.10^{-3}$	$1.10^{-3}$
	E (kcal / mol)	15	17
	A (1 / s)	$2.10^{10}$	$2.10^{12}$
Exponential 3	$\mu$ (%)	$10.10^{-3}$	$2.10^{-3}$
	E (kcal / mol)	17	19
	A (1 / s)	$7.10^{10}$	$1.10^{13}$
Exponential 4	$\mu$ (%)	$8.10^{-3}$	$3.10^{-3}$
	E (kcal / mol)	18	21
	A (1 / s)	$3.10^{10}$	$3.10^{12}$
Exponential 5	$\mu$ (%)	$3.10^{-3}$	$6.10^{-3}$
	E (kcal / mol)	18	21
	A (1 / s)	$2.10^9$	$8.10^{10}$

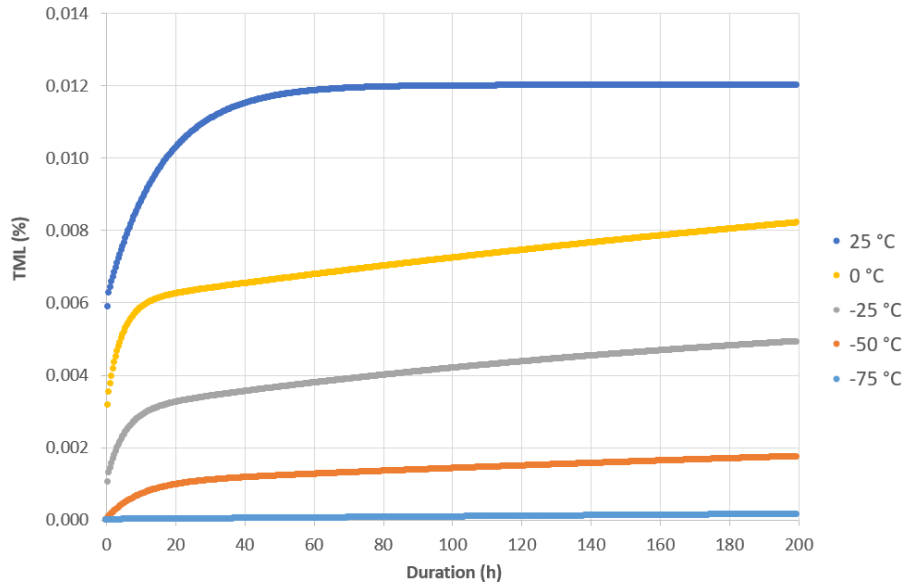
**Fitting is pretty good** → same order of magnitude for  $\mu$  (cf. experimental data)

**Activation energy** below 20 kcal/mole → desorption (< 10 kcal / mol) and diffusion (< 15 kcal / mol)

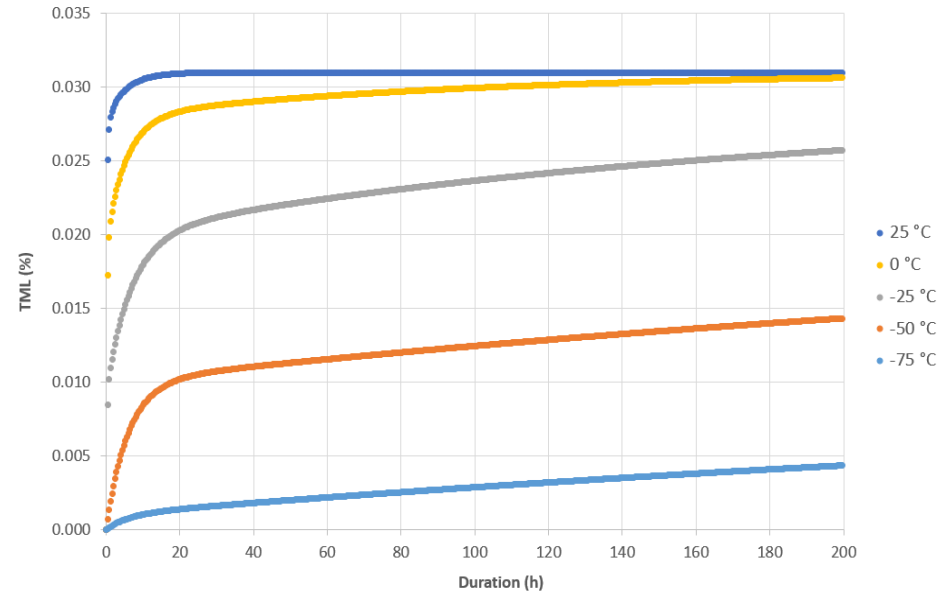
# Prediction

Prediction from coefficients ( $\mu$ , E, A)<sup>1</sup> to 5 found with fitting

*RTV-S 691 adhesive*



*Cryogenic MLI*



Outgassing is negligible at -75 °C but starts at -50 °C  
Models might need to be reworked

## Conclusion

- CNES facilities were modified and are now ready to perform tests for different materials at cryogenic temperature.
- Outgassing starts at -75 °C (mainly water) and at -50 °C for some small solvent fragments but outgassing remains dominated by water desorption.

Temperature	-75 °C	-50 °C	-25 °C	0 °C	25 °C
<b>TML for RTV-S 691 adhesive (%)</b>	0	0.001	0.002	0.003	0.004
<b>TML for cryogenic MLI (%)</b>	0.002	0.01	0.01	0.007	0.001

- RGA data processing could be improved to decrease S/R ratio.
- Models and predictions need to be reworked and validated at low temperature to be realistic.
- Some materials have already been tested (epoxy glues, composite and other MLI) and each material exhibits its own behavior at low temperature.
- A paper is currently being written.

**Thanks!**